

TOSHIBA Fast Recovery Diode Silicon Diffused Type

S5295B, S5295G, S5295J

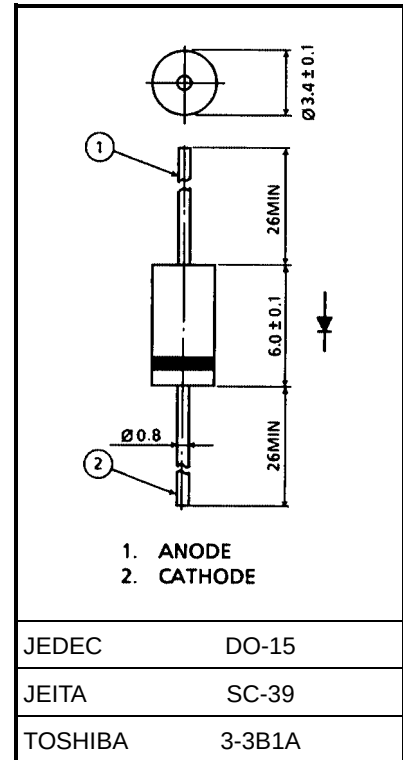
High Speed Rectifier Applications (fast recovery)

Unit: mm

- Average Forward Current: $I_F (AV) = 0.5 \text{ A}$ ($T_a = 50^\circ\text{C}$)
- Repetitive Peak Reverse Voltage: $V_{RRM} = 100, 400, 600 \text{ V}$
- Reverse Recovery Time: $1.5 \mu\text{s}$
- Plastic Mold Type.

Maximum Ratings

Characteristics		Symbol	Rating	Unit
Repetitive peak reverse voltage	S5295B	V _{RRM}	100	V
	S5295G		400	
	S5295J		600	
Reverse voltage (DC)	S5295B	V _R	75	V
	S5295G		300	
	S5295J		500	
Average forward current (Ta = 50°C)		I _F (AV)	0.5	A
Peak one cycle surge forward current (non repetitive)		I _{FSM}	30 (50 Hz)	A
			33 (60 Hz)	
Junction temperature		T _j	−40 to 125	°C
Storage temperature range		T _{stg}	−40 to 125	°C



Weight: 0.42 g (typ.)

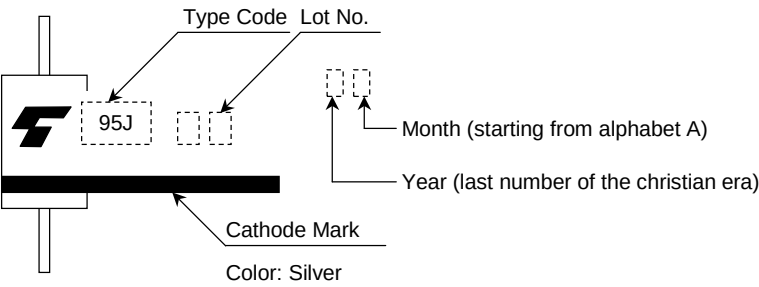
Electrical Characteristics ($T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak forward voltage	V_{FM}	$I_{FM} = 1.0 \text{ A}$	—	—	1.5	V
Repetitive peak reverse current	I_{RRM}	$V_{RRM} = \text{Rated}$	—	—	10	μA
Reverse recovery time	t_{rr}	$I_F = 20 \text{ mA}$, $I_R = 1 \text{ mA}$	—	—	1.5	μs
Forward recovery voltage	V_{fr}	$I_F = 100 \text{ mA}$, $t_r = 100 \text{ ns}$, $t_w = 5 \mu\text{s}$	—	—	10	V

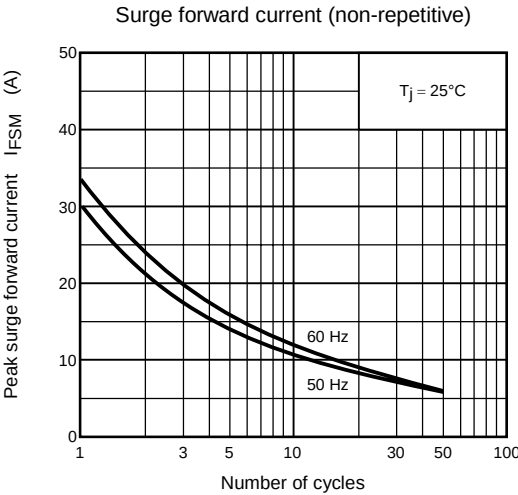
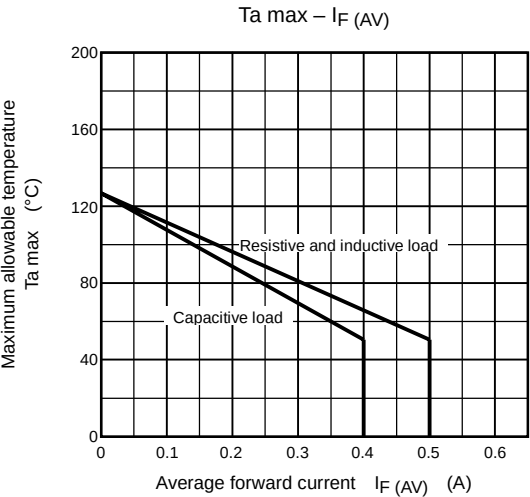
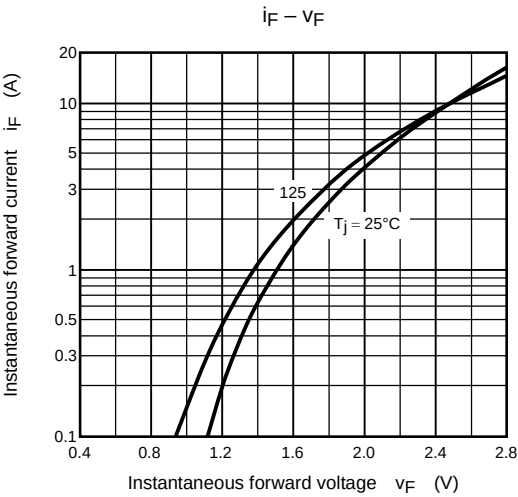
Note1: Soldering: 5 mm is the minimum to be kept between case and soldering part.

Note2: Lead bending: 5 mm is the minimum to be kept from the case when bend the lead wire.

Marking



Code	Type
95B	S5295B
95G	S5295G
95J	S5295J



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000707EAA

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